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Dated: September 2, 2004

Signature:

Richard H. Anderson
(Richard H. Anderson)

Docket No.: 27702/10047C-1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Gary Wentworth et al.

Application No.: 10/706,386

Art Unit: 1714

Filed: November 12, 2003

Examiner: Not Yet Assigned

For: LIQUID FORM ESTER/RESIN ADHESION
PROMOTER

PRELIMINARY AMENDMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Amendment has been made to claims 1, 2, 42 and 46 in view of EP 0 073 174 A1 cited in applicants' latest Information Disclosure Statement. Please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 26 of this paper.